

- Ideal Front-End Filter for 916.5 MHz Wireless Receivers
- Low-Loss, Coupled-Resonator Quartz Design
- Simple External Impedance Matching
- Rugged TO39 Hermetic Package
- Complies with Directive 2002/95/EC (RoHS)



The RF3181 is a low-loss, compact, and economical surface-acoustic-wave (SAW) filter designed to provide front-end selectivity in 916.5 MHz receivers. Receiver designs using this filter include superhet with 10.7 MHz or 500 kHz IF, direct conversion and superregen. Typical applications of these receivers are wireless remote-control and security devices operating in the USA under FCC Part 15 and in Canada under DoC RSS-210.

This coupled-resonator filter (CRF) uses selective null placement to provide suppression, typically greater than 40 dB, of the LO and image spurious responses of superhet receivers with 10.7 MHz IF. RFM's advanced SAW design and fabrication technology is utilized to achieve high performance and very low loss with simple external impedance matching (not included). Quartz construction provides excellent frequency stability over a wide temperature range.

RF3181

916.50 MHz SAW Filter



Electrical Characteristics

Characteristic		Sym	Notes	Minimum	Typical	Maximum	Units
Center Frequency at 25°C	Absolute Frequency	f _C	1, 2	916.400	916.500	916.600	MHz
	Tolerance from 916.500 MHz	Δf_{C}				±100	kHz
Insertion Loss		IL	1		3.2	5	dB
3 dB Bandwidth		BW3	1,2	600	750	1000	kHz
Rejection	at f _C - 21.4 MHz (Image)			33	40		
	at f _C - 10.7 MHz (LO)		1	15	37		dB
	Ultimate				80		
Temperature	Operating Case Temp.	Т _С		-40		+85	°C
	Turnover Temperature	Т _О	.		25		°C
	Turnover Frequency	f _O	3, 4		f _C		MHz
	Freq. Temp. Coefficient	FTC			0.032		ppm/°C ²
Frequency Aging	Absolute Value during the First Year	fA	5		≤10		ppm/yr
External Impedance	Series Inductance	L 1		Coilci	Coilcraft 8.2 nH Chip Inductor		nH
	Shunt Capacitance	С	1	1		5	pF
Lid Symbolization (in addition to Lot and/or Date Codes)		RFM RF3181					



CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

Notes:

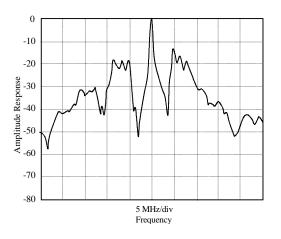
- Unless noted otherwise, all measurements are made with the filter installed in the specified test fixture which is connected to a 50 Ω test system with VSWR ≤ 1.2:1. The test fixture L and C are adjusted for minimum insertion loss at the filter center frequency, f_c. Note that insertion loss, bandwidth, and passband shape are dependent on the impedance matching component values and guality.
- 2. The frequency f_c is defined as the midpoint between the 3dB frequencies.
- 3. Unless noted otherwise, specifications apply over the entire specified operating temperature range.
- 4. The turnover temperature, T_o, is the temperature of maximum (or turnover) frequency, f_o. The nominal frequency at any case temperature, T_c, may be calculated from: $f = f_0 [1 FTC (T_0 T_c)^2]$.
- Frequency aging is the change in fc with time and is specified at +65°C or less. Aging may exceed the specification for prolonged temperatures above +65°C. Typically, aging is greatest the first year after manufacture, decreasing significantly in subsequent years.
- 6. The design, manufacturing process, and specifications of this device are subject to change without notice.
- 7. One or more of the following U.S. Patents apply: 4,54,488, 4,616,197, and others pending.
- 8. All equipment designs utilizing this product must be approved by the appropriate government agency prior to manufacture or sale.

Absolute Maximum Ratings

Rating	Value	Units
Incident RF Power	+13	dBm
DC Voltage Between Any Two Pins (Observe ESD Precautions)	±30	VDC
Case Temperature ⁵	-40 to +85	°C
Soldering Temperature (10 seconds / 5 cycles max.)	260	°C

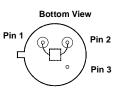
Typical Filter Response

Typical filter responses are shown below. The actual response is dependent on external impedance matching and circuit layout. Illustrated frequencies and minimum rejection for LO and IMAGE are shown only for superhet receivers with 10.7 MHz IF.

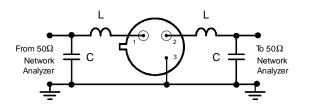


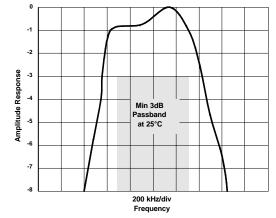
Electrical Connections

Pin	Connection		
1	Input or Output		
2	Output or Input		
3	Case Ground		

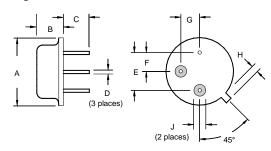


Typical Test Circuit





Case Design



Dimensions	Millim	neters	Inches		
Dimensions	Min	Max	Min	Мах	
A		9.40		0.370	
В		3.18		0.125	
С	2.50	3.50	0.098	0.138	
D	0.46 Nominal		0.018 Nominal		
E	5.08 Nominal		0.200 Nominal		
F	2.54 Nominal		0.100 Nominal		
G	2.54 Nominal		0.100 Nominal		
Н		1.02		0.040	
J	1.40		0.055		